General Purpose Metallized Polyester Film Capacitors

# R82, Radial, 5 mm Lead Spacing, 50 – 400 VDC (Automotive Grade)

## Overview

The R82 is constructed of metallized polyester film (wound or stacked technology) with radial leads of tinned wire. Radial leads are electrically welded to the contact metal layer on the ends of the capacitor winding. The capacitor is encapsulated with thermosetting resin in a box of material meeting the UL 94 V–0 requirements.

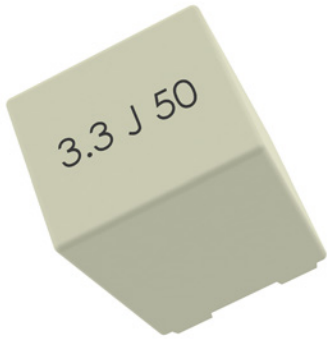
Automotive grade devices meet the demanding Automotive Electronics Council's AEC–Q200 qualification requirements.

## Applications

Typical applications include blocking, coupling, decoupling, timing, and oscillator circuits. Not suitable for across-the-line application (see Suppressor Capacitors).

## Benefits

- Voltage range: 50 – 400 VDC
- Capacitance range: 0.001 – 4.7 µF
- Lead Spacing: 5 mm
- Capacitance tolerance: ±5%, ±10%, ±20%
- Climatic category: 55/105/56
- Operating temperature range of −55°C to +105°C
- RoHS compliance and lead-free terminations
- Tape & Reel packaging in accordance with IEC 60286–2
- Self-healing
- Automotive grade (AEC–Q200)




## Part Number System

| R82 | D | C | 3470 | AA | 60 | J |
|---|---|---|---|---|---|---|
| Series | Rated Voltage (VDC) | Length (mm) | Capacitance Code (pF) | Packaging | Internal Use | Capacitance Tolerance |
| Metallized Polyester | C = 50<br>D = 63<br>E = 100<br>I = 250<br>M = 400 | C = 5.0 | The last three digits represent significant figures. First digit specifies the number of zeros to be added. | See Ordering Options Table | 30<br>50<br>60<br>70 | J = ±5%<br>K = ±10%<br>M = ±20% |

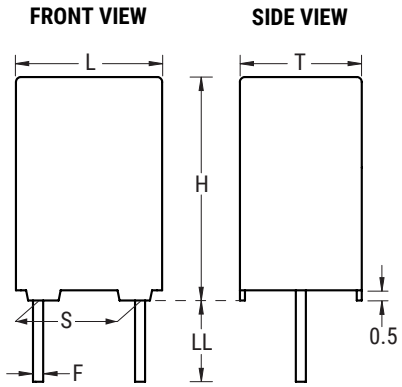


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## Ordering Options Table

| Lead Spacing Nominal (mm) | Type of Leads and Packaging | LL Lead Length (mm) | Lead and Packaging Code |
|---|---|---|---|
| 5 | **Standard Lead and Packaging Options** | | |
| | Bulk – Short leads | 4 +1.5/−0 | AA |
| | Ammo Pack | $H_0$ = 18.5 ±0.5 | DQ |
| | **Other Lead and Packaging Options** | | |
| | Tape & Reel (Standard Reel Ø 355 mm) | $H_0$ = 18.5 ±0.5 | CK |
| | Bulk – Short leads | 2.7 +0.5/−0 | JA |
| | Bulk – Short leads | 3.5 +0.5/−0 | JB |
| | Bulk – Short leads | 10 ±1 | JC |
| | Bulk – Short leads | 4.0 +0.5/−0 | JE |
| | Bulk – Short leads | 3.2 +0.3/−0.2 | JH |
| | Bulk – Long leads | 17 +1/−2 | Z3 |

## Dimensions – Millimeters




| S | | T | | H | | L | | F | |
|---|---|---|---|---|---|---|---|---|---|
| Nominal | Tolerance | Nominal | Tolerance | Nominal | Tolerance | Nominal | Tolerance | Nominal | Tolerance |
| 5.0 | ±0.4 | 2.5 | +0.1/−0.5 | 6.5 | +0.1/−0.5 | 7.2 | +0.2/−0.5 | 0.5 | ±0.05 |
| 5.0 | ±0.4 | 3.5 | +0.1/−0.5 | 7.5 | +0.1/−0.5 | 7.2 | +0.2/−0.5 | 0.5 | ±0.05 |
| 5.0 | ±0.4 | 4.5 | +0.1/−0.5 | 9.5 | +0.1/−0.5 | 7.2 | +0.3/−0.5 | 0.5 | ±0.05 |
| 5.0 | ±0.4 | 5.0 | +0.1/−0.5 | 10.0 | +0.1/−0.5 | 7.2 | +0.3/−0.5 | 0.5 | ±0.05 |
| 5.0 | ±0.4 | 6.0 | +0.1/−0.5 | 11.0 | +0.1/−0.5 | 7.2 | +0.3/−0.5 | 0.5 | ±0.05 |
| 5.0 | ±0.4 | 7.2 | +0.1/−0.5 | 13.0 | +0.1/−0.5 | 7.2 | +0.3/−0.5 | 0.6 | ±0.05 |

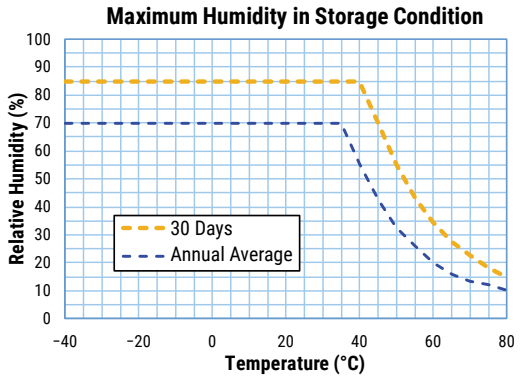
**Note: See Ordering Options Table for lead length (LL/$H_0$) options.**

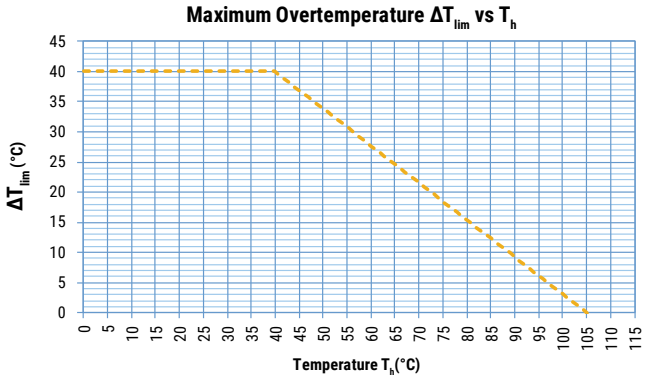
## Performance Characteristics

| | | | | | | | |
|---|---|---|---|---|---|---|---|
| Dielectric | Polyester film (polyethylene terephthalate). | | | | | | |
| Plates | Metal layer deposited by evaporation under vacum. | | | | | | |
| Winding | Non-inductive type. | | | | | | |
| Leads | Tinned wire. | | | | | | |
| Protection | Plastic case, thermosetting resin filled. Box material is solvent resistant and flame retardant according to UL94. | | | | | | |
| Related Documents | IEC 60384–2 | | | | | | |
| Rated Voltage $V_R$ (VDC) | 50 | 63 | 100 | 250 | 250 | 400 | 400 |
| Rated Voltage $V_R$ (VAC) | 30 | 40 | 63 | 140 | 160 | 160 | 200 |
| Capacitance Range (µF) | 2.2 – 4.7 | 0.1 – 1.5 | 0.001 – 1 | 0.022 – 0.22 | 0.0068 – 0.15 | 0.0068 – 0.068 | 0.001 – 0.047 |
| Capacitance Values | E6 series (IEC 60063) measured at 1 kHz and +20 ±1°C | | | | | | |
| Capacitance Tolerance | ±5%, ±10%, ±20% | | | | | | |
| Operating Temperature Range | –55°C to 105°C | | | | | | |
| Rated Temperature $T_R$ | +85°C | | | | | | |
| Voltage Derating | Above +85°C DC and AC voltage derating is 1.25%/°C | | | | | | |
| Climatic Category | 55/105/56 IEC 60068–1 | | | | | | |
| Storage Conditions | Storage time: ≤ 24 months from the date marked on the label package | | | | | | |
| | Average relative humidity per year ≤ 70% | | | | | | |
| | RH ≤ 85% for 30 days randomly distributed throughout the year | | | | | | |
| | Dew is absent | | | | | | |
| | Temperature: –40 to 80°C (see "Maximum Humidity in Storage Conditions" graph below) | | | | | | |
| Test Voltage | 1.4 x $V_R$ VDC for 2 seconds (between terminations) at +25°C ±5°C | | | | | | |
| Capacitance Drift | Maximum 3% after a 2 year storage period at a temperature of +10°C to +40°C and a relative humidity of 40% to 60% | | | | | | |
| Reliability (Reference IEC 61709) | Operational life > 200,000 hours | | | | | | |
| | Failure rate ≤ 1 FIT, T = +40°C, V = 0.5 x $V_R$ | | | | | | |
| | Failure criteria: open or short circuit, cap. change > 10%, DF 2 times the catalog limits, IR < 0.005 x initial limit | | | | | | |
| Maximum Pulse Steepness | dV/dt according to Table 1. For peak to peak voltages lower than rated voltage (Vpp <$V_R$), the specified dv/dt can be multiplied by the factor $V_R$/Vpp | | | | | | |
| Temperature Coefficient | +400 (±200) ppm/°C at 1 kHz | | | | | | |
| Self Inductance (Lead Length ~ 2 mm) | Approximately 7 nH. Maximum 1nH per 1 mm lead and capacitor length. | | | | | | |

## Performance Characteristics cont.

<table>
<tr><td rowspan="4">Dissipation Factor tanδ</td><td colspan="4">Maximum Values at 25°C ±5°C</td></tr>
<tr><td>Frequency</td><td colspan="2">C ≤ 0.1 µF</td><td>C > 0.1 µF</td></tr>
<tr><td>1 kHz</td><td colspan="2">0.80%</td><td>0.80%</td></tr>
<tr><td>10 kHz</td><td colspan="2">1.20%</td><td>1.20%</td></tr>
<tr><td>100 kHz</td><td colspan="2">2.50%</td><td>–</td></tr>
<tr><td rowspan="4">Insulation Resistance</td><td colspan="4">Measured at +25°C ±5°C, according to IEC 60384–2</td></tr>
<tr><td colspan="4">Minimum Values Between Terminals</td></tr>
<tr><td>Voltage charge/time</td><td>C ≤ 0.33 µF</td><td>0.33 µF < C ≤ 1.0 µF</td><td>C > 1.0 µF</td></tr>
<tr><td>50 VDC for $V_R$ < 100 VDC<br>1 minute</td><td>≥ 15,000 MΩ</td><td>≥ 5,000 MΩ • µF</td><td>≥ 1,000 MΩ • µF</td></tr>
<tr><td>100 VDC for $V_R$ ≥ 100 VDC<br>1 minute</td><td colspan="3">≥ 30,000 MΩ</td></tr>
</table>



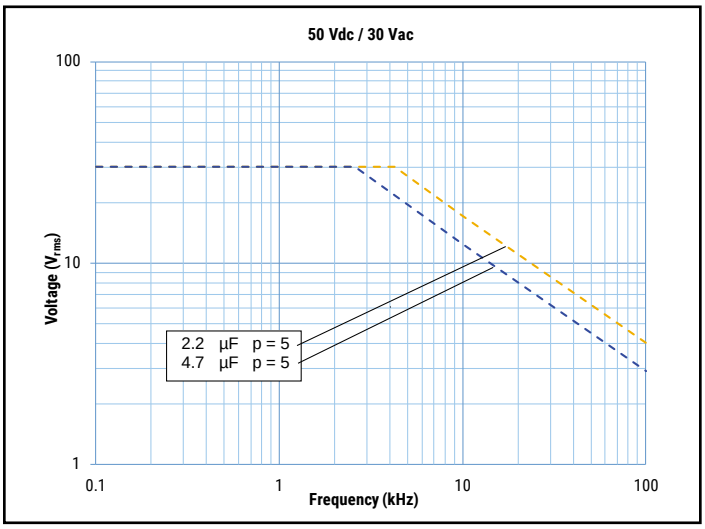



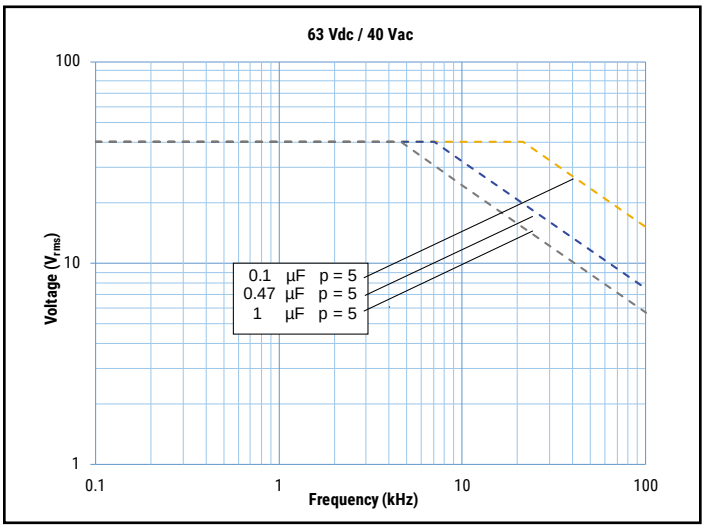

*$T_h$ is the maximum ambient temperature surrounding the capacitor or hottest contact point (e.g. tracks), whichever is higher, in the worst operation conditions in °C.*

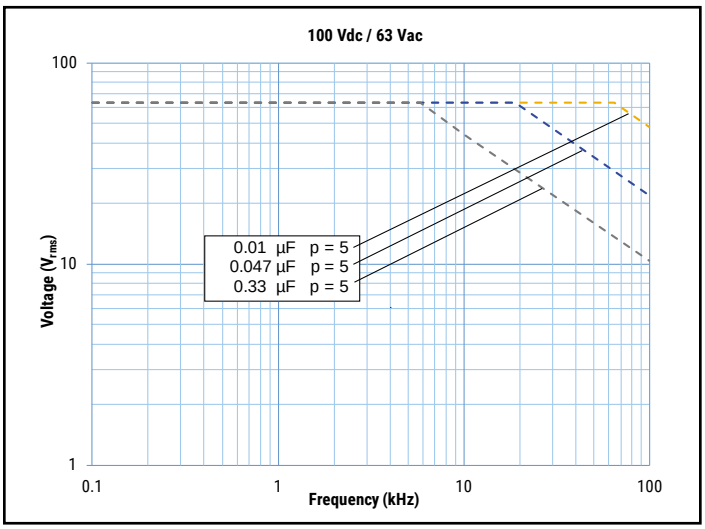
## Qualification

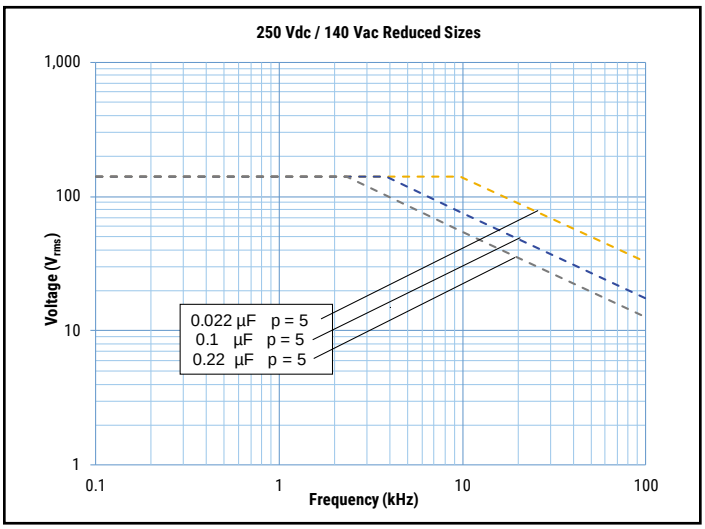
Automotive grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC–Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC–Q200, please visit their website at www.aecouncil.com.

## Maximum Voltage ($V_{rms}$) vs. Frequency (Sinusoidal Waveform/Th ≤ 40°C)

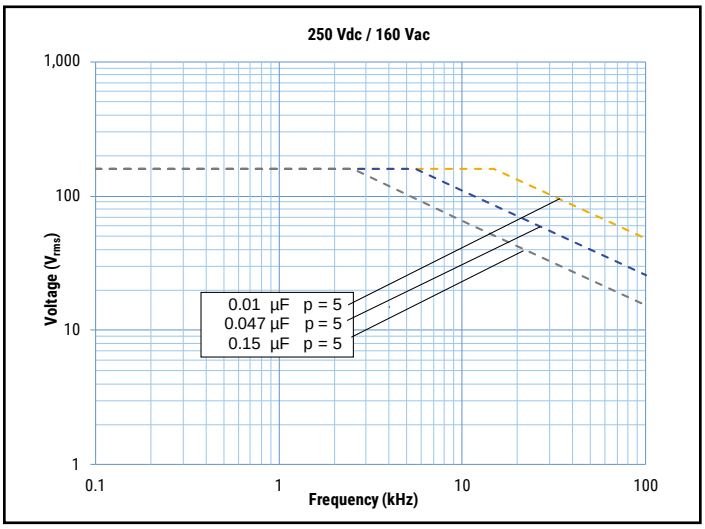


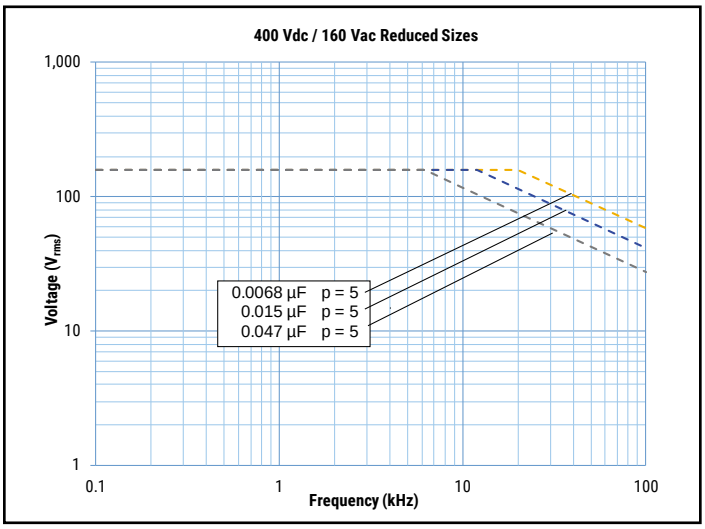



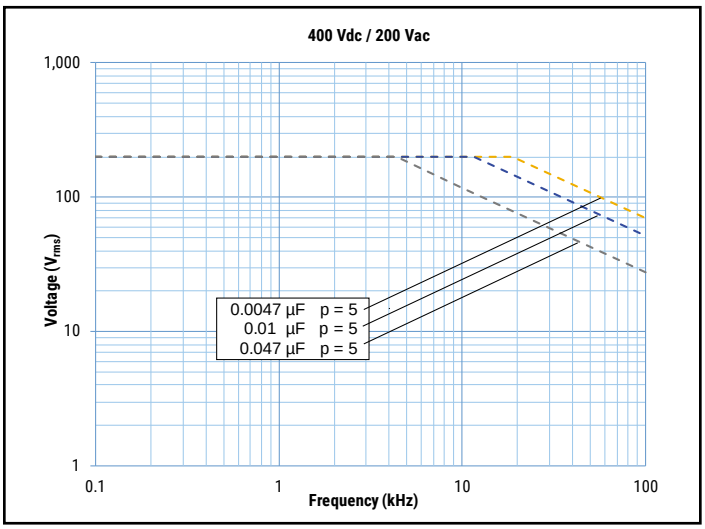



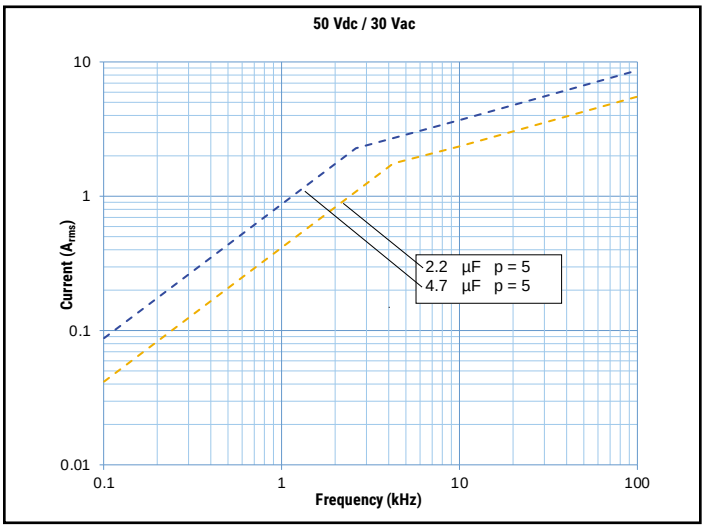
## Maximum Voltage ($V_{rms}$) vs. Frequency (Sinusoidal Waveform/Th ≤ 40°C) cont.

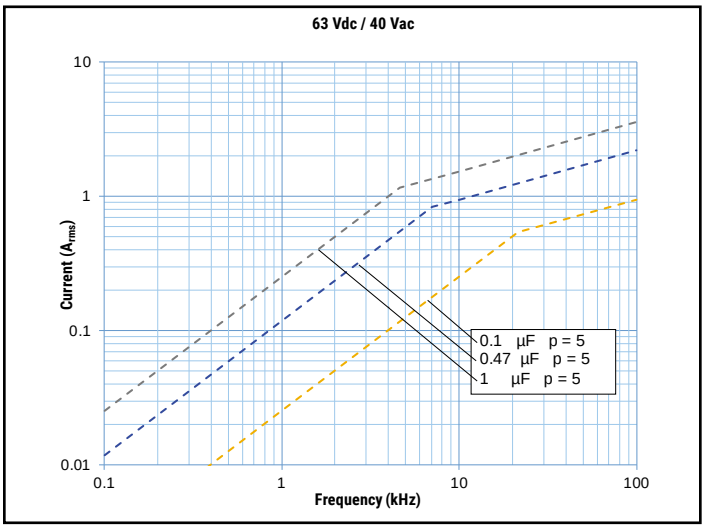


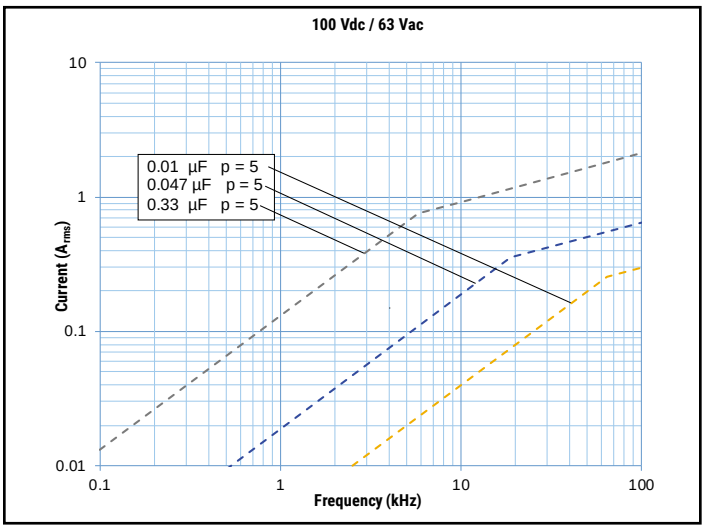



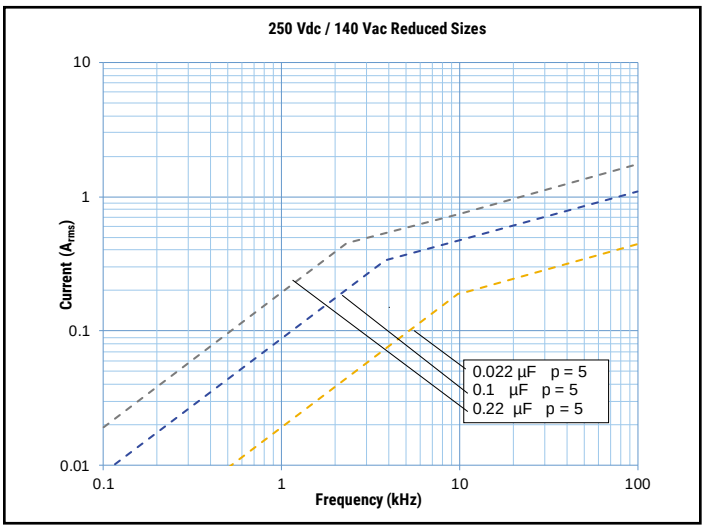



## Maximum Current ($I_{rms}$) vs. Frequency (Sinusoidal Waveform/Th ≤ 40°C)

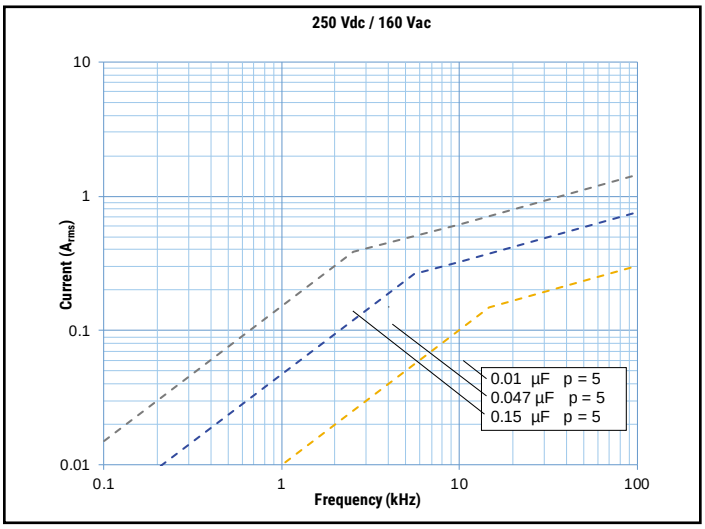


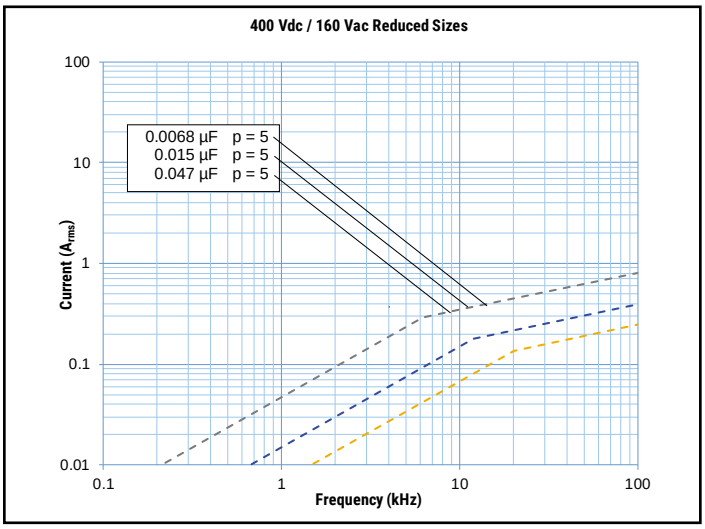



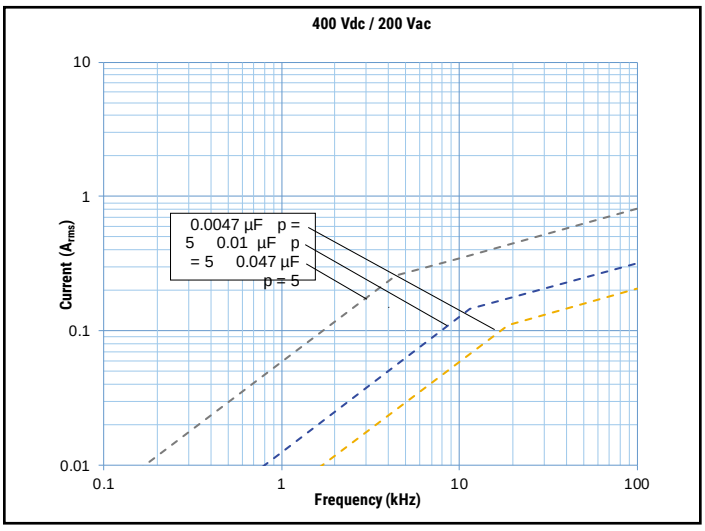



## Maximum Current ($I_{rms}$) vs. Frequency (Sinusoidal Waveform/Th ≤ 40°C) cont.



## Environmental Test Data

| Damp Heat, Steady State Test | Test Conditions: | | Performances |
|---|---|---|---|
| | Temperature:<br>Relative humidity (RH):<br>Test duration: | +40°C ±2°C<br>93% ±2%<br>56 days | Δ C/C ≤ 5%,<br>Δ tanδ ≤ 0.5% at 1 kHz<br>IR after test ≥ 50% of initial limit |
| **Endurance Test** | **Test Conditions** | | **Performances** |
| | Temperature:<br>Voltage applied:<br>Test duration: | +105°C ±2°C<br>1.25 x $V_C$<br>2,000 hours | Δ C/C ≤ 5%,<br>Δ tanδ ≤ 0.003 at 10 kHz for C ≤ 1 µF<br>Δ tanδ ≤ 0.002 at 1 kHz for C > 1 µF<br>IR after test ≥ 50% of initial limit |
| **Resistance to Soldering Heat Test** | **Test Conditions** | | **Performances** |
| | Solder bath temperature:<br>Dipping time (with heat screen): | 260°C ±5°C<br>10 seconds ±1 second | \|Δ C/C\| ≤ 2%,<br>Δ tanδ ≤ 0.003 at 10 kHz for C ≤ 1µF<br>Δ tanδ ≤ 0.002 at 1 kHz for C > 1µF<br>IR after test ≥ initial limit |

## Environmental Compliance

All KEMET MKT capacitors are RoHS Compliant.

## Table 1 – Ratings & Part Number Reference

| VDC | VAC | Capacitance Value (µF) | Dimensions in mm | | | Lead Spacing (S) | dV/dt (V/µs) | Maximum $K_0$ ($V^2$/µs) | KEMET Part Number | Legacy Part Number |
|---|---|---|---|---|---|---|---|---|---|---|
| | | | T | H | L | | | | | |
| 50 | 30 | 2.2 | 6.0 | 11.0 | 7.2 | 5.0 | 100 | 10000 | 82CC4220(1)70(2) | R82CC4220(1)70(2) |
| **50** | **30** | **3.3** | **7.2** | **13.0** | **7.2** | **5.0** | **25** | **2500** | **82CC4330(1)30(2)** | **R82CC4330(1)30(2)** |
| **50** | **30** | **4.7** | **7.2** | **13.0** | **7.2** | **5.0** | **25** | **2500** | **82CC4470(1)30(2)** | **R82CC4470(1)30(2)** |
| 63 | 40 | 0.10 | 2.5 | 6.5 | 7.2 | 5.0 | 160 | 20160 | 82DC3100(1)50(2) | R82DC3100(1)50(2) |
| 63 | 40 | 0.15 | 2.5 | 6.5 | 7.2 | 5.0 | 160 | 20160 | 82DC3150(1)60(2) | R82DC3150(1)60(2) |
| 63 | 40 | 0.22 | 2.5 | 6.5 | 7.2 | 5.0 | 160 | 20160 | 82DC3220(1)60(2) | R82DC3220(1)60(2) |
| 63 | 40 | 0.33 | 3.5 | 7.5 | 7.2 | 5.0 | 160 | 20160 | 82DC3330(1)60(2) | R82DC3330(1)60(2) |
| 63 | 40 | 0.47 | 3.5 | 7.5 | 7.2 | 5.0 | 160 | 20160 | 82DC3470(1)60(2) | R82DC3470(1)60(2) |
| 63 | 40 | 0.68 | 4.5 | 9.5 | 7.2 | 5.0 | 160 | 20160 | 82DC3680(1)60(2) | R82DC3680(1)60(2) |
| 63 | 40 | 1.0 | 5.0 | 10.0 | 7.2 | 5.0 | 160 | 20160 | 82DC4100(1)60(2) | R82DC4100(1)60(2) |
| 63 | 40 | 1.5 | 6.0 | 11.0 | 7.2 | 5.0 | 160 | 20160 | 82DC4150(1)60(2) | R82DC4150(1)60(2) |
| 100 | 63 | 0.0010 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 40000 | 82EC1100(1)50(2) | R82EC1100(1)50(2) |
| 100 | 63 | 0.0015 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 40000 | 82EC1150(1)50(2) | R82EC1150(1)50(2) |
| 100 | 63 | 0.0022 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 40000 | 82EC1220(1)50(2) | R82EC1220(1)50(2) |
| **VDC** | **VAC** | **Capacitance Value (µF)** | **T (mm)** | **H (mm)** | **L (mm)** | **Lead Spacing (S)** | **dV/dt (V/µs)** | **Max $K_0$ ($V^2$/µs)** | **KEMET Part Number** | **Legacy Part Number** |

*(1) Insert lead and packaging code. See Ordering Options Table for available options.*
*(2) J = 5%, K = 10%, M = 20%*
***Bold denotes wound capacitor technology***

## Table 1 – Ratings & Part Number Reference cont.

| VDC | VAC | Capacitance Value (µF) | Dimensions in mm | | | Lead Spacing (S) | dV/dt (V/µs) | Maximum $K_0$ ($V^2$/µs) | KEMET Part Number | Legacy Part Number |
|---|---|---|---|---|---|---|---|---|---|---|
| | | | T | H | L | | | | | |
| 100 | 63 | 0.0033 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 40000 | 82EC1330(1)50(2) | R82EC1330(1)50(2) |
| 100 | 63 | 0.0047 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 40000 | 82EC1470(1)50(2) | R82EC1470(1)50(2) |
| 100 | 63 | 0.0068 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 40000 | 82EC1680(1)50(2) | R82EC1680(1)50(2) |
| 100 | 63 | 0.010 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 40000 | 82EC2100(1)50(2) | R82EC2100(1)50(2) |
| 100 | 63 | 0.015 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 40000 | 82EC2150(1)50(2) | R82EC2150(1)50(2) |
| 100 | 63 | 0.022 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 40000 | 82EC2220(1)50(2) | R82EC2220(1)50(2) |
| 100 | 63 | 0.033 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 40000 | 82EC2330(1)50(2) | R82EC2330(1)50(2) |
| 100 | 63 | 0.047 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 40000 | 82EC2470(1)60(2) | R82EC2470(1)60(2) |
| 100 | 63 | 0.056 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 40000 | 82EC2560(1)60(2) | R82EC2560(1)60(2) |
| 100 | 63 | 0.068 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 40000 | 82EC2680(1)60(2) | R82EC2680(1)60(2) |
| 100 | 63 | 0.10 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 40000 | 82EC3100(1)70(2) | R82EC3100(1)70(2) |
| 100 | 63 | 0.15 | 3.5 | 7.5 | 7.2 | 5.0 | 200 | 40000 | 82EC3150(1)70(2) | R82EC3150(1)70(2) |
| 100 | 63 | 0.22 | 3.5 | 7.5 | 7.2 | 5.0 | 200 | 40000 | 82EC3220(1)70(2) | R82EC3220(1)70(2) |
| 100 | 63 | 0.33 | 4.5 | 9.5 | 7.2 | 5.0 | 200 | 40000 | 82EC3330(1)70(2) | R82EC3330(1)70(2) |
| 100 | 63 | 0.47 | 4.5 | 9.5 | 7.2 | 5.0 | 200 | 40000 | 82EC3470(1)70(2) | R82EC3470(1)70(2) |
| 100 | 63 | 0.68 | 5.0 | 10.0 | 7.2 | 5.0 | 200 | 40000 | 82EC3680(1)70(2) | R82EC3680(1)70(2) |
| 100 | 63 | 1.00 | 6.0 | 11.0 | 7.2 | 5.0 | 200 | 40000 | 82EC4100(1)70(2) | R82EC4100(1)70(2) |
| 250 | 140 | 0.022 | 2.5 | 6.5 | 7.2 | 5.0 | 130 | 65000 | 82IC2220(1)60(2) | R82IC2220(1)60(2) |
| 250 | 140 | 0.047 | 3.5 | 7.5 | 7.2 | 5.0 | 130 | 65000 | 82IC2470(1)60(2) | R82IC2470(1)60(2) |
| 250 | 140 | 0.068 | 3.5 | 7.5 | 7.2 | 5.0 | 130 | 65000 | 82IC2680(1)60(2) | R82IC2680(1)60(2) |
| 250 | 140 | 0.10 | 4.5 | 9.5 | 7.2 | 5.0 | 130 | 65000 | 82IC3100(1)60(2) | R82IC3100(1)60(2) |
| 250 | 140 | 0.15 | 5.0 | 10.0 | 7.2 | 5.0 | 130 | 65000 | 82IC3150(1)60(2) | R82IC3150(1)60(2) |
| 250 | 140 | 0.22 | 6.0 | 11.0 | 7.2 | 5.0 | 130 | 65000 | 82IC3220(1)60(2) | R82IC3220(1)60(2) |
| 250 | 160 | 0.0068 | 2.5 | 6.5 | 7.2 | 5.0 | 250 | 125000 | 82IC1680(1)50(2) | R82IC1680(1)50(2) |
| 250 | 160 | 0.010 | 2.5 | 6.5 | 7.2 | 5.0 | 250 | 125000 | 82IC2100(1)50(2) | R82IC2100(1)50(2) |
| 250 | 160 | 0.015 | 2.5 | 6.5 | 7.2 | 5.0 | 250 | 125000 | 82IC2150(1)50(2) | R82IC2150(1)50(2) |
| 250 | 160 | 0.022 | 3.5 | 7.5 | 7.2 | 5.0 | 250 | 125000 | 82IC2220(1)50(2) | R82IC2220(1)50(2) |
| 250 | 160 | 0.033 | 3.5 | 7.5 | 7.2 | 5.0 | 250 | 125000 | 82IC2330(1)50(2) | R82IC2330(1)50(2) |
| 250 | 160 | 0.047 | 4.5 | 9.5 | 7.2 | 5.0 | 250 | 125000 | 82IC2470(1)50(2) | R82IC2470(1)50(2) |
| 250 | 160 | 0.068 | 4.5 | 9.5 | 7.2 | 5.0 | 250 | 125000 | 82IC2680(1)50(2) | R82IC2680(1)50(2) |
| 250 | 160 | 0.10 | 5.0 | 10.0 | 7.2 | 5.0 | 250 | 125000 | 82IC3100(1)55(2) | R82IC3100(1)55(2) |
| 250 | 160 | 0.15 | 6.0 | 11.0 | 7.2 | 5.0 | 250 | 125000 | 82IC3150(1)50(2) | R82IC3150(1)50(2) |
| 400 | 160 | 0.0068 | 2.5 | 6.5 | 7.2 | 5.0 | 200 | 160000 | 82MC1680(1)60(2) | R82MC1680(1)60(2) |
| 400 | 160 | 0.015 | 3.5 | 7.5 | 7.2 | 5.0 | 200 | 160000 | 82MC2150(1)60(2) | R82MC2150(1)60(2) |
| 400 | 160 | 0.033 | 4.5 | 9.5 | 7.2 | 5.0 | 200 | 160000 | 82MC2330(1)60(2) | R82MC2330(1)60(2) |
| 400 | 160 | 0.047 | 5.0 | 10.0 | 7.2 | 5.0 | 200 | 160000 | 82MC2470(1)60(2) | R82MC2470(1)60(2) |
| 400 | 160 | 0.068 | 6.0 | 11.0 | 7.2 | 5.0 | 200 | 160000 | 82MC2680(1)60(2) | R82MC2680(1)60(2) |
| 400 | 200 | 0.0010 | 2.5 | 6.5 | 7.2 | 5.0 | 400 | 320000 | 82MC1100(1)50(2) | R82MC1100(1)50(2) |
| 400 | 200 | 0.0015 | 2.5 | 6.5 | 7.2 | 5.0 | 400 | 320000 | 82MC1150(1)50(2) | R82MC1150(1)50(2) |
| 400 | 200 | 0.0022 | 2.5 | 6.5 | 7.2 | 5.0 | 400 | 320000 | 82MC1220(1)50(2) | R82MC1220(1)50(2) |
| 400 | 200 | 0.0033 | 2.5 | 6.5 | 7.2 | 5.0 | 400 | 320000 | 82MC1330(1)50(2) | R82MC1330(1)50(2) |
| 400 | 200 | 0.0047 | 2.5 | 6.5 | 7.2 | 5.0 | 400 | 320000 | 82MC1470(1)50(2) | R82MC1470(1)50(2) |
| 400 | 200 | 0.0068 | 3.5 | 7.5 | 7.2 | 5.0 | 400 | 320000 | 82MC1680(1)50(2) | R82MC1680(1)50(2) |
| 400 | 200 | 0.010 | 3.5 | 7.5 | 7.2 | 5.0 | 400 | 320000 | 82MC2100(1)50(2) | R82MC2100(1)50(2) |
| 400 | 200 | 0.015 | 4.5 | 9.5 | 7.2 | 5.0 | 400 | 320000 | 82MC2150(1)50(2) | R82MC2150(1)50(2) |
| 400 | 200 | 0.022 | 4.5 | 9.5 | 7.2 | 5.0 | 400 | 320000 | 82MC2220(1)50(2) | R82MC2220(1)50(2) |
| 400 | 200 | 0.033 | 5.0 | 10.0 | 7.2 | 5.0 | 400 | 320000 | 82MC2330(1)50(2) | R82MC2330(1)50(2) |
| 400 | 200 | 0.047 | 6.0 | 11.0 | 7.2 | 5.0 | 400 | 320000 | 82MC2470(1)50(2) | R82MC2470(1)50(2) |
| **VDC** | **VAC** | **Capacitance Value (µF)** | **T (mm)** | **H (mm)** | **L (mm)** | **Lead Spacing (S)** | **dV/dt (V/µs)** | **Max $K_0$ ($V^2$/µs)** | **KEMET Part Number** | **Legacy Part Number** |

*(1) Insert lead and packaging code. See Ordering Options Table for available options.*
*(2) J = 5%, K = 10%, M = 20%*

## Soldering Process

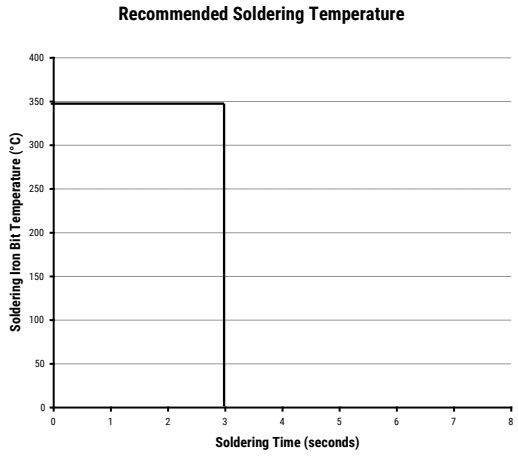
The implementation of the RoHS directive has resulted in the selection of SnAgCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of 183°C for SnPb eutectic alloy to 217 – 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 – 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 to 15 mm), and great care has to be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760–1 Edition 2, serves as a solid guideline for successful soldering. Please see Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result to degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

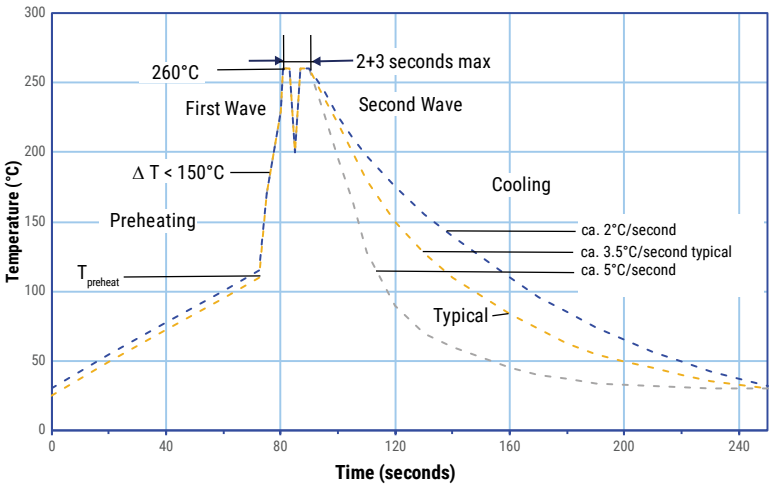
### Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.




The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

### Wave Soldering Recommendations



## Soldering Process cont.

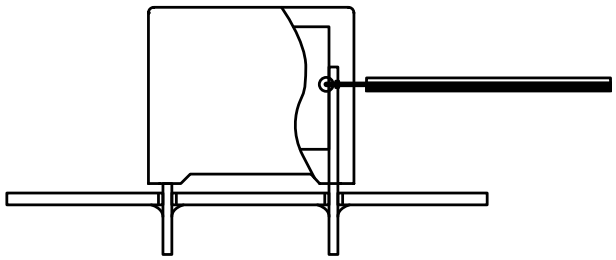
**Wave Soldering Recommendations cont.**

1. The table indicates the maximum set-up temperature of the soldering process Figure 1.

| Dielectric Film Material | Maximum Preheat Temperature | | Maximum Peak Soldering Temperature | |
|---|---|---|---|---|
| | Capacitor Pitch ≤ 15 mm | Capacitor Pitch > 15 mm | Capacitor Pitch ≤ 15 mm | Capacitor Pitch > 15 mm |
| Polyester | 130°C | 130°C | 270°C | 270°C |
| Polypropylene | 110°C | 130°C | 260°C | 270°C |
| Paper | 130°C | 140°C | 270°C | 270°C |
| Polyphenylene Sulphide | 150°C | 160°C | 270°C | 270°C |

2. The maximum temperature measured inside the capacitor:
   Set the temperature so that inside the element the maximum temperature is below the limit:

| Dielectric Film Material | Maximum temperature measured inside the element |
|---|---|
| Polyester | 160°C |
| Polypropylene | 110°C |
| Paper | 160°C |
| Polyphenylene Sulphide | 160°C |



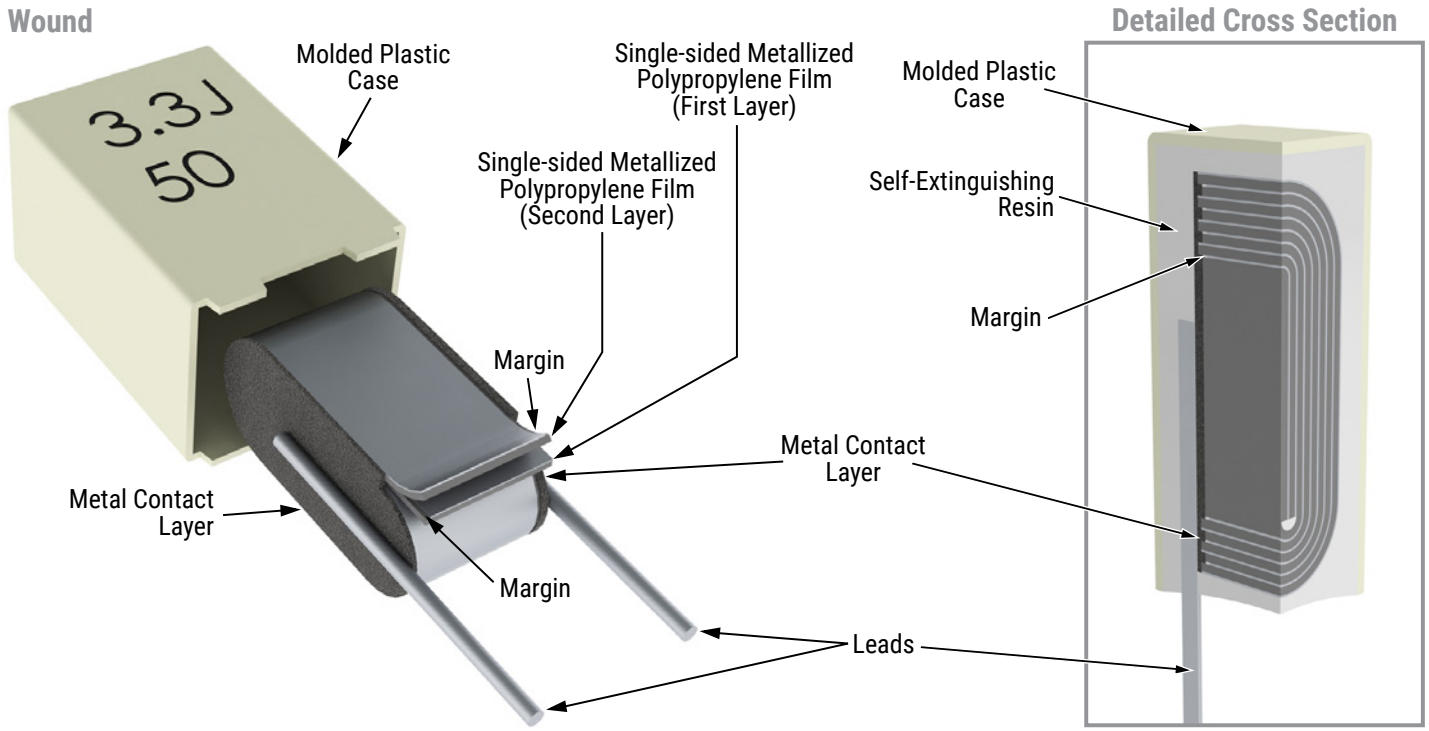
*Temperature monitored inside the capacitor.*

**Selective Soldering Recommendations**

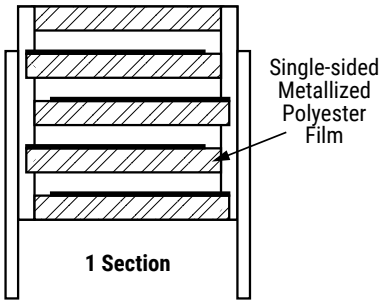
Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document, **however, instead of two baths, there is only one bath with a time from 3 to 10 seconds.** In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.

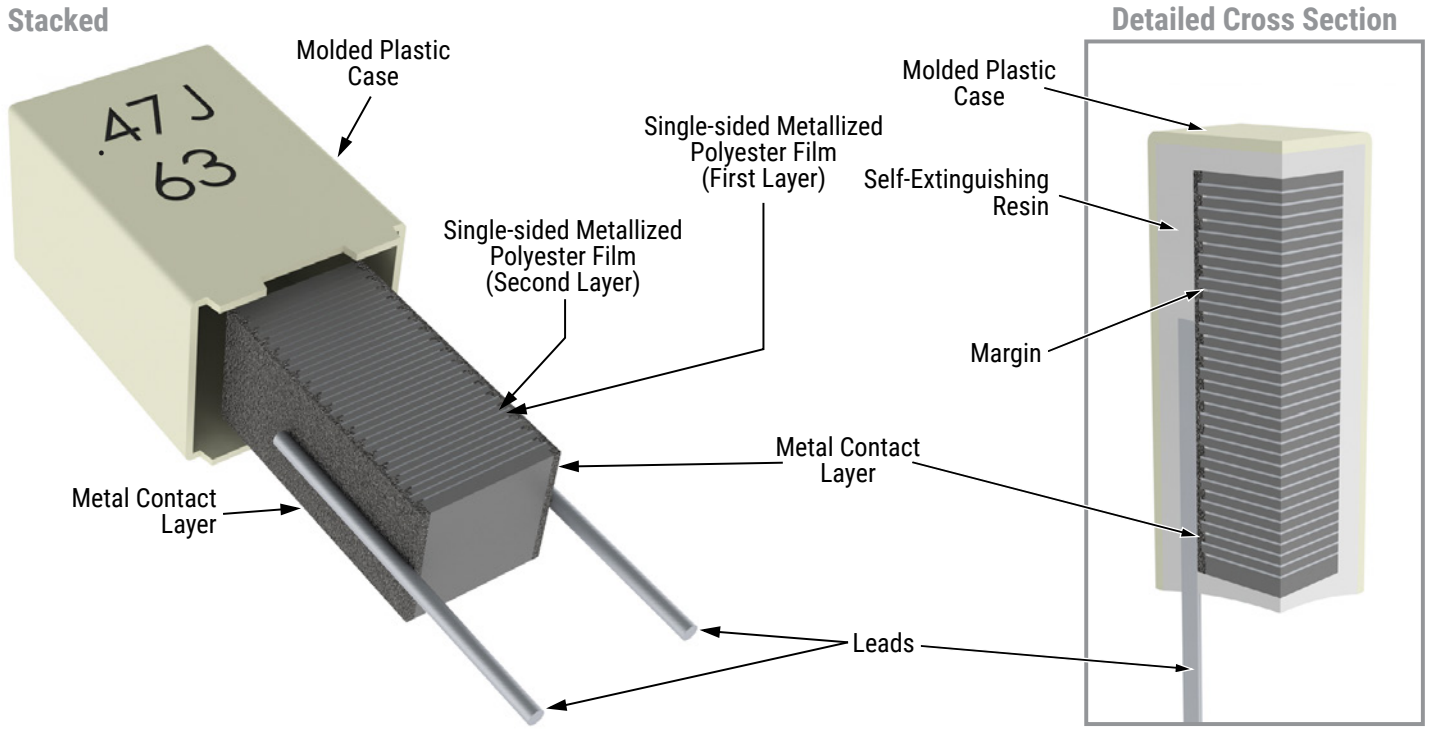
## Construction




### Winding Scheme

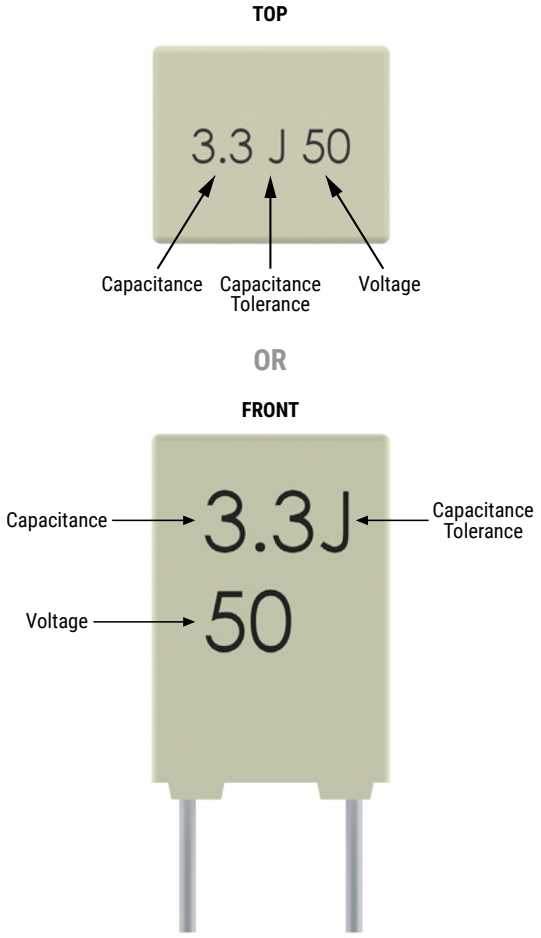


## Construction cont.

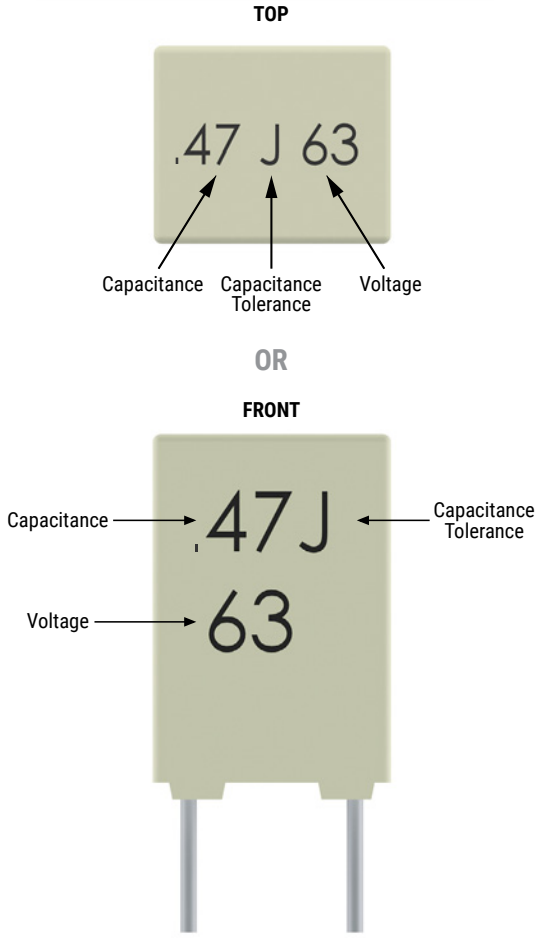


## Marking

Wound




Stacked

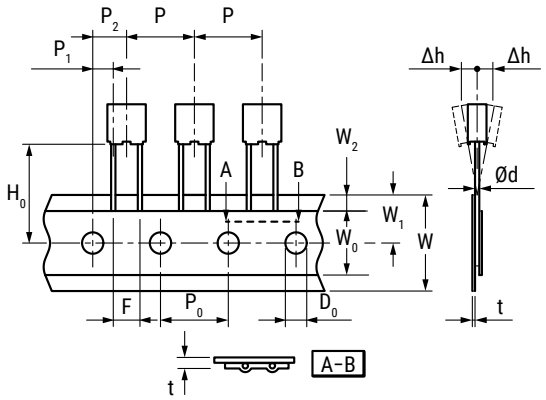



## Packaging Quantities

| Lead Spacing | Thickness (mm) | Height (mm) | Length (mm) | Bulk Short Leads | Bulk Long Leads | Standard Reel 355 mm | Ammo Taped |
|---|---|---|---|---|---|---|---|
| 5 | 2.5 | 6.5 | 7.2 | 3,000 | 4,000 | 2,500 | 3,500 |
| | 3.5 | 7.5 | 7.2 | 2,000 | 3,000 | 1,800 | 2,500 |
| | 4.5 | 9.5 | 7.2 | 1,500 | 2,000 | 1,400 | 1,900 |
| | 5.0 | 10.0 | 7.2 | 1,000 | 1,500 | 1,200 | 1,700 |
| | 6.0 | 11.0 | 7.2 | 2,000 | 1,000 | 1,000 | 1,400 |
| | 7.2 | 13.0 | 7.2 | 1,500 | 750 | 800 | 1,150 |

# Lead Taping & Packaging (IEC 60286–2)

**Figure 1 — Lead Spacing 5 & 7.5 mm**



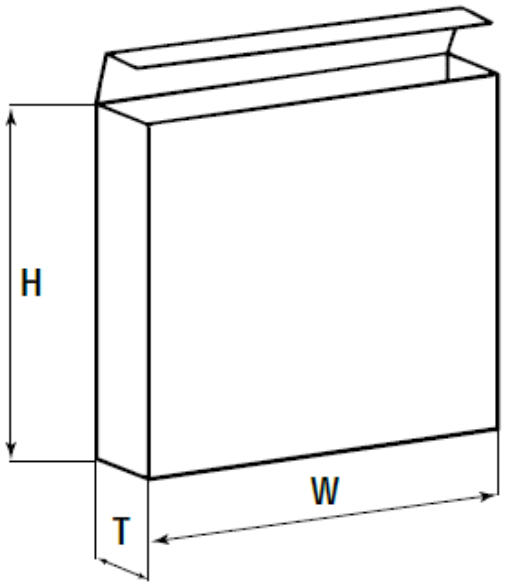

| Description | Symbol | Dimensions (mm) | |
|---|---|---|---|
| | | Lead Spacing | Tolerance |
| | | 5 | |
| | | Figure 1 | |
| Lead wire diameter | d | 0.5 – 0.6 | ±0.05 |
| Taping lead space | P | 12.7 | ±1 |
| Feed hole lead space | $P_0$ | 12.7 | ±0.2* |
| Centering of the lead wire | $P_1$ | 3.85 | ±0.7 |
| Centering of the body | $P_2$ | 6.35 | ±1.3 |
| Lead spacing | F | 5 | +0.6/–0.1 |
| Component alignment | Δh | 0 | ±2 |
| Height of component from tape center | $H_0$** | 18.5 | ±0.5 |
| Carrier tape width | W | 18 | +1/–0.5 |
| Hold down tape width | $W_0$ | 6 | Minimum |
| Hole position | $W_1$ | 9 | ±0.5 |
| Hold down tape position | $W_2$ | 3 | Maximum |
| Feed hole diameter | $D_0$ | 4 | ±0.2 |
| Tape thickness | t | 0.7 | ±0.2 |

**Maximum 1 mm on 20 lead spaces.*
***$H_0$ = 16.5 mm is available upon request.*
*For orders of capacitors with lead space = 7.5 mm, please specify the requested version (Figure 1 or Figure 2).*

## Ammo Specifications

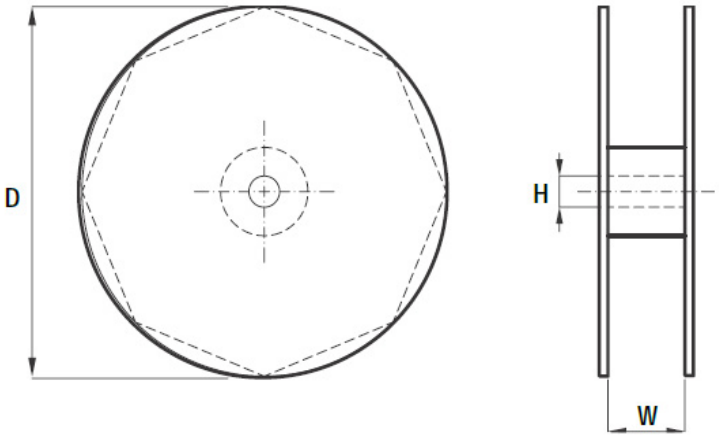
| Dimensions in mm | | |
|---|---|---|
| H | W | T |
| 360 * | 340 | 59 |

** Lower dimension available upon request (maximum 295 mm)*




## Reel Specifications

| Dimensions in mm | | |
|---|---|---|
| D | H | W |
| 355 | 30 | 55 maximum |



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